



1A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placeme
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

• Case: SOD-128

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 2 whisker testPolarity: Indicated by cathode band

• Weight: 0.027g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l _F	1	Α		
V _{RRM}	200 - 1000	V		
I _{FSM}	30	Α		
T _J MAX	150	°C		
Package	SOD-128			
Configuration	Single die			









SOD-128



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	S1DFSH	S1GFSH	S1JFSH	S1KFSH	S1MFSH	UNIT
Marking code on the device		S1DFS	S1GFS	S1JFS	S1KFS	S1MFS	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	560	700	V
Forward current	I _F			1			Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30			А		
Junction temperature	ΤJ	-55 to +150			°C		
Storage temperature	T _{STG}	-55 to +150			°C		



Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{OJL}	29	°C/W
Junction-to-ambient thermal resistance	Reja	82	°C/W
Junction-to-case thermal resistance	Rejc	30	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 0.5A, T _J = 25°C	VF	0.91	1.00	V
	I _F = 1.0A, T _J = 25°C		0.99	1.10	V
	I _F = 0.5A, T _J = 125°C		0.78	0.87	V
	I _F = 1.0A, T _J = 125°C		0.85	0.95	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	1	μΑ
	T _J = 125°C	- I _R	-	50	μΑ
Junction capacitance	1MHz, V _R = 4.0V	Сл	9	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE(1)	PACKAGE	PACKING		
S1xFSH	SOD-128	14,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 200V(S1DFSH) to 1000V(S1MFSH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

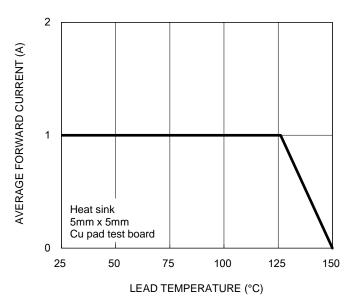


Fig.2 Typical Junction Capacitance

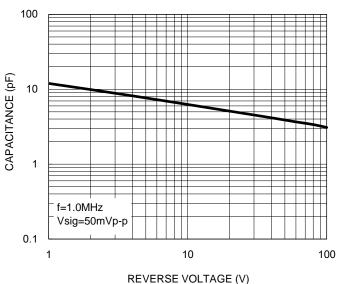


Fig.3 Typical Reverse Characteristics

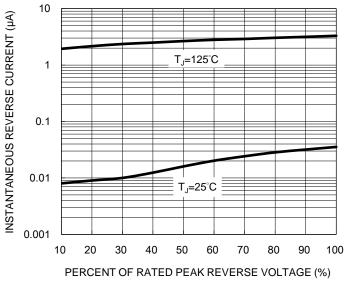
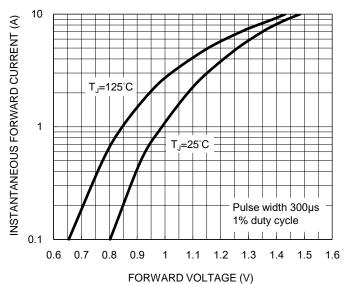


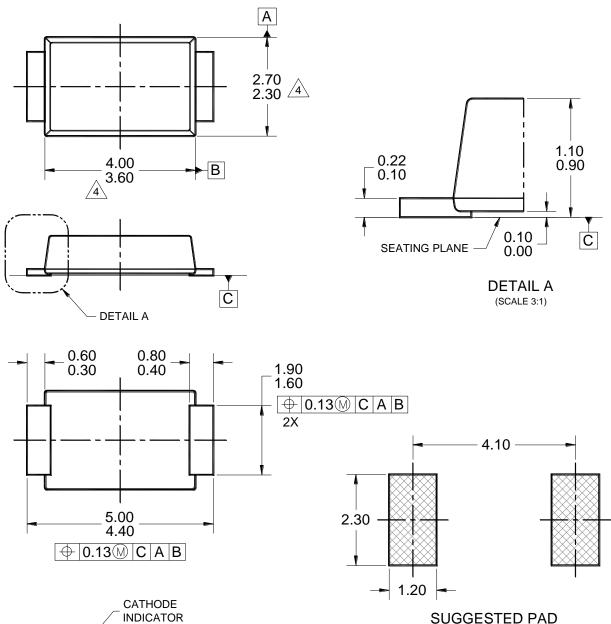
Fig.4 Typical Forward Characteristics

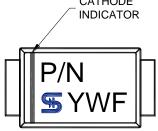




PACKAGE OUTLINE DIMENSIONS

SOD-128





MARKING DIAGRAM

P/N = MARKING CODE YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.

LAYOUT

- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AD, ISSUE B.
- MODED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5. DWG NO. REF: HQ2SD07-SOD128-039 REV A.



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.